

N-Channel 30-V (D-S) MOSFET

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- · Level 3 MOS

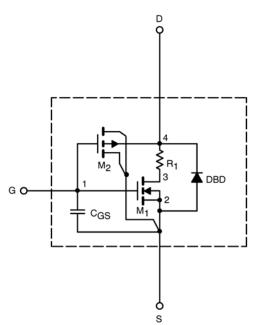
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static			-		
Gate Threshold Voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = 250 μ A	1.9		V
On-State Drain Current ^a	I _{D(on)}	$V_{\text{DS}} \geq 5 \text{ V}, V_{\text{GS}} \text{ = } 10 \text{ V}$	165		А
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 6 A	0.027	0.028	Ω
		V_{GS} = 4.5 V, I _D = 4.9 A	0.038	0.041	
Forward Transconductance ^a	g _{fs}	V_{DS} = 1.5 V, I_{D} = 6 A	13	12	S
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 1.7 A, $V_{\rm GS}$ = 0 V	0.80	0.80	V
Dynamic ^b			-		
Total Gate Charge	Qg	V_{DS} = 15 V, V_{GS} = 10 V, I_{D} = 6 A	8	8.6	nC
Gate-Source Charge	Q _{gs}		1.8	1.8	
Gate-Drain Charge	Q _{gd}		1.5	1.5	
Turn-On Delay Time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} \textbf{V}_{\text{DD}} = \textbf{15} \ \textbf{V}, \ \textbf{R}_{\text{L}} = \textbf{15} \ \Omega \\ \textbf{I}_{\text{D}} \cong \textbf{1} \ \textbf{A}, \ \textbf{V}_{\text{GEN}} = \textbf{10} \ \textbf{V}, \ \textbf{R}_{\text{G}} = \textbf{6} \ \Omega \end{array}$	16	10	ns
Rise Time	t _r		8	15	
Turn-Off Delay Time	t _{d(off)}		23	25	
Fall Time	t _f		6	10	

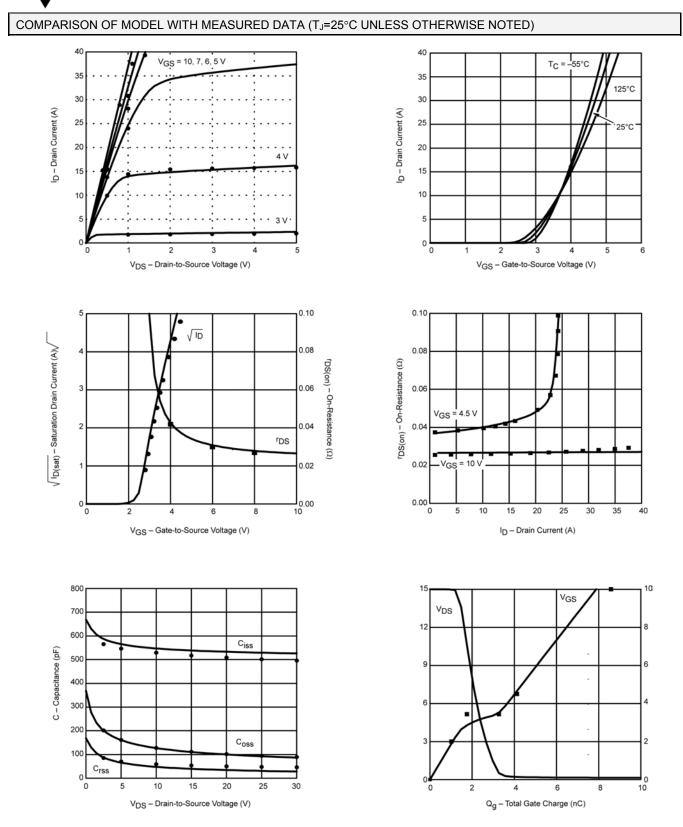
Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.



SPICE Device Model Si3456BDV

Vishay Siliconix



Note: Dots and squares represent measured data.



Vishay

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